

FEP Fluoropolymer Extruded Films

FLUORINATED ETHYLENE PROPYLENE FILM FOR USE IN HIGH-PERFORMANCE APPLICATIONS

TCI's FEP films are produced from Fluorinated Ethylene Propylene (FEP) resin by a melt extrusion casting process. TCI's FEP films offer all the benefits of fluorinated films, such as high temperature and chemical resistance, non-stick properties, and superior dielectric performance. FEP films can be heat-sealed, thermoformed, laminated to various substrates, and serve as a melt adhesive.

TCI's FEP Films Are Available In Four Grades

FEP PG (Premium Grade)

- Manufactured out of 100% virgin premium grade FEP resin with MFI range of 5-10
- Best suited for applications where high dielectric performance is required, such as PCB laminates and wire & cable applications
- Grade of choice for protective, decorative, see-through and other applications where visual appearance and clarity are important
- Meets ASTM D3368 specification for Type I FEP film

FEP WG (Welding Grade)

- Offers 15-20% cost savings vs. PG grade
- Perfect economical solution for heat sealing, welding, and other melt adhesive applications that don't have high aesthetics requirements
- Meets ASTM D3368 standards for Type I general purpose FEP film

FEP MR (Mold Release Grade)

- Due to its superior non-stick performance and up to 400°F (205°C) service temperature, FEP is the material of choice in high temperature composite molding
- Features high elongation and excellent conformability to complex contoured molds
- Standard colors include red, violet and white. Custom colors available upon request
- Available in a variety of perforated patterns
- Meets ASTM D3368 standards for Type IV mold release FEP film

FEP HG (High Molecular Weight Grade)

- Offers superior stress-crack resistance and flex endurance performance (250,000 cycles MIT test)
- Material of choice for chemical tank linings, pump diaphragms and rupture discs
- Meets ASTM D3368 standards for Type III FEP film



TCI's FEP Films Characteristics

- Thickness range from 0.0005" to 0.010" (12 to 250 mµ)
- Standard width: up to 60" (1,524 mm)
- Thicknesses >0.002": up to 62" (1,575 mm) wide
- FEP HG is available in thicknesses 0.005", 0.010", 0.020" and 0.030"
- 0.020" and 0.030" are available up to 49" (1250 mm) wide
- Any slit widths available upon request
- Continuous service temperature range from -400° to 400°F (-240 to 205°C)
- Intermittent service temperature up to 500°F (260°C)
- Superior anti-stick and low friction properties
- Chemically inert and solvent resistant to most chemicals
- Outstanding dielectric properties over a wide range of frequencies and temperatures.
- Excellent light transmission and clarity
- Free of plasticizers, processing aids, or additives
- Acceptable for food contact
- Meets the requirements of US Pharmacopeia protocol for USP class VI plastic
- Bondable (plasma treated or chemically etched) surfaces available

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FLUORINATED ETHYLENE PROPYLENE FILM FOR USE IN HIGH-PERFORMANCE APPLICATIONS

			FEP PG	FEP WG	FEP MR	FEP HG
General Properties	Units	ASTM D792			2.15	
Specific Gravity	ft ² /lb/mil	ASTM D792	90			
Area Yield	It /ID/MII	111 04	V-0			
Flammability	%	UL-94				
Water Absoption	70				<0.01	
Mechanical Properties	:	A CTM DOOG	3,500			F 000
Tensile Strength	psi	ASTM D882	·		5,000	
Elongation at Break	%	ASTM D882	300			350
Tensile Modulus	psi	ASTM D882	70,000			70,000
Initial Tear Strength (2 mil film)	g	ASTM D1004	550			550
Propagation Tear Strength (2 mil film)	g	ASTM D1922	250			250
Folding Endurance (MIT)	cycles, ave.	ASTM D2176	10.000			250.000
Thermal Properties	3, 5.53, 473.			10,000		200,000
Continuous Use Temp	°F (°C)	UL-746 B	400 (205)			400 (205)
	. (5)	02 : :0 2		.00 (200)		.00 (200)
Melt Point	°F (°C)	ASTM D3418	500 (260)		520 (270)	
Coeff. of Lin. Thermal Expansion	in/(in °F)	ASTM D696	5.5x10 ⁻⁵		5.5x10 ⁻⁵	
Electrical Properties						
Dielectric Strength (1mil film)	volts / mil	ASTM D149	6,500	n/a		6,500
Dielectric Contant 1kHz		ASTM D150	2.0	n/a		2.0
Dissipation Factor, 1kHz		ASTM D150	i	0.0003 n/a		0.0003
Surface Resistivity	ohm/sq	ASTM D257	1x10 ¹⁵	n/a		1x10 ¹⁵
Optical Properties						
Refractive Index		ASTM D542	1.34 n/a		1.34	
Solar Transmission	%	ASTM E424	96	n/a		96
Product Offering				•		
Width	inches (mm)		0.5-2 mil: up to 60" (1,524); 3-10 mil: up to 62" (1,575) 0.5 - 10 (12.5 - 250)		up to 62" (1,575) 20 mil: up to 49.25" (1,250) 2 –20 mil	
Thickness	mils (µm)			0.5 - 10 (12.5 -	250)	2 –20 11111
Standard Colors			Clear	Clear Tinted	White, Red, Violet	Clear
Surface Treatments Available						
Chemical Etching			•	•		•
Plasma Treatment			•	•		•
Applications, Markets						
Composite Molding Process: Release Films					•	
Chemical Process / Equipment			•	•		•
Heat Sealing / Welding / Melt Adhesive			•	•		
Electrical / Electronics			•			
Medical			•			•
Optical /Photovoltaics			•			
Protective/Decorative			•			

The above table contains typical representative values and is not to be used for product specification. Contact TCI for a formal specification.

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